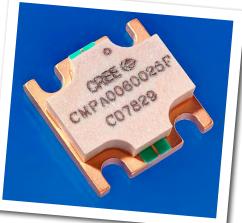


CMPA0060025F 25 W, 20 MHz-6000 MHz, GaN MMIC Power Amplifier

Cree's CMPA0060025F is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT) based monolithic microwave integrated circuit (MMIC). GaN has superior properties compared to silicon or gallium arsenide, including higher breakdown voltage, higher saturated electron drift velocity and higher thermal conductivity. GaN HEMTs also offer greater power density and wider bandwidths compared to Si and GaAs transistors. This MMIC enables extremely wide bandwidths to be achieved in a small footprint screw-down package.



PN: CMPA0060025F Package Type: 780019

Typical Performance Over 20 MHz - 6.0 GHz $(T_c = 25^{\circ}c)$

Parameter	20 MHz	0.5 GHz	1.0 GHz	2.0 GHz	3.0 GHz	4.0 GHz	5.0 GHz	6.0 GHz	Units
Gain	21.4	20.1	19.3	16.7	16.6	16.8	15.7	15.5	dB
Output Power @ $P_{IN} = 32 \text{ dBm}$	26.9	30.2	26.3	23.4	24.5	24.0	20.9	18.6	W
Power Gain @ P_{IN} = 32 dBm	12.3	12.8	12.2	11.7	11.9	11.8	11.3	10.7	dB
Efficiency @ $P_{IN} = 32 \text{ dBm}$	63	55	40	31	33	31	28	26	%

Note¹: $V_{_{DD}}$ = 50 V, $I_{_{DQ}}$ = 500 mA

Features

- 17 dB Small Signal Gain
- 25 W Typical P_{SAT}
- Operation up to 50 V
- High Breakdown Voltage
- High Temperature Operation
- 0.5" x 0.5" total product size

Applications

- Ultra Broadband Amplifiers
- Test Instrumentation
- EMC Amplifier
 Drivers

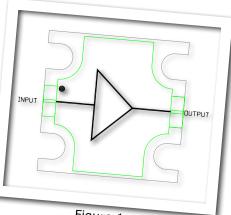


Figure 1.

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Absolute Maximum Ratings (not simultaneous) at 25°C

Parameter	Symbol	Rating	Units
Drain-source Voltage	V _{DSS}	84	VDC
Gate-source Voltage	V _{gs}	-10, +2	VDC
Storage Temperature	Τ _{stg}	-65, +150	°C
Operating Junction Temperature	T,	225	°C
Maximum Forward Gate Current	I _{GMAX}	4	mA
Soldering Temperature ¹	Τ _s	245	°C
Screw Torque	τ	40	in-oz
Thermal Resistance, Junction to Case	$R_{_{ ext{ hetaJC}}}$	3.3	°C/W
Case Operating Temperature ^{2,3}	Т _с	-40, +150	°C

Note:

¹ Refer to the Application Note on soldering at <u>www.cree.com/products/wireless_appnotes.asp</u>

 $^{\rm 2}$ Measured for the CMPA0060025F at P $_{\rm IN}$ = 32 dBm.

Electrical Characteristics (Frequency = 20 MHz to 6.0 GHz unless otherwise stated; $T_c = 25$ °C)

Characteristics		Syn	nbol	Min.	Тур.	Max	. U	nits	Conditions	
DC Characteristics										
Gate Threshold Voltage	e ²	V _{(G}	S)TH	-3.8	-3.0	-2.3		V	$V_{_{DS}} = 20 V, \Delta$	$I_{D} = 20 \text{ mA}$
Gate Quiescent Voltage	9	V _{(G}	iS)Q	-	-2.7	-	١	/DC	$V_{\text{DD}} = 50 \text{ V, I}_{\text{I}}$	$_{DQ}$ = 500 mA, P _{IN} = 32 dBm
Saturated Drain Currer	nt	I	DC	-	12	-		А	$V_{\rm DS}$ = 12 V, V	v _{GS} = 2.0 V
RF Characteristics¹										
Power Output at P _{out} @) 4.5 GHz	Po	UT1	41.0	42.8	-	C	lBm	$V_{\text{DD}} = 50$ V, I_{I}	$_{DQ}$ = 500 mA, P _{IN} = 32 dBm
Power Output at P _{out} @) 5.0 GHz	Po	UT2	41.0	43.3	-	c	lBm	$V_{_{DD}} = 50 \text{ V, I}_{_{II}}$	$_{DQ}$ = 500 mA, P _{IN} = 32 dBm
Power Output at P _{out} @	0 6.0 GHz	Po	UT3	41.0	42.9	-	C	lBm	$V_{\text{DD}} = 50 \text{ V, I}_{\text{I}}$	$_{DQ}$ = 500 mA, P _{IN} = 32 dBm
Drain Efficiency at P _{out}	@ 4.5 GHz	η	1	18.0	24.1	-		%	$V_{\text{DD}} = 50 \text{ V, I}_{\text{D}}$	$_{DQ}$ = 500 mA, P _{IN} = 32 dBm
Drain Efficiency at P _{out}	@ 5.0 GHz	η	2	18.0	28.0	-		%	$V_{\text{DD}} = 50 \text{ V, I}_{\text{I}}$	$_{DQ}$ = 500 mA, P _{IN} = 32 dBm
Drain Efficiency at P _{out}	@ 6.0 GHz	η	3	18.0	27.2	-		%	$V_{\text{DD}} = 50 \text{ V, I}_{\text{I}}$	$_{DQ}$ = 500 mA, P _{IN} = 32 dBm
Output Mismatch Stres	S	VS	WR	-	-	5:1		Ψ	2	It all phase angles, $p_{Q} = 500 \text{ mA}, P_{IN} = 32 \text{ dBm}$
Small Signal RF Chai	racteristics									
		S21			S11			S22		
Frequency	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Conditions
0.02 GHz - 0.25 GHz	18.0	19.3	23.7	-	-4.1	-2.5	-	-8.5	-4.5	$V_{_{\rm DD}}$ = 50 V, $I_{_{\rm DQ}}$ = 500 mA
0.25 GHz - 0.5 GHz	18.0	19.8	22.0	-	-6.8	-3.5	-	-8.9	-4.5	$V_{_{\rm DD}}$ = 50 V, $I_{_{\rm DQ}}$ = 500 mA
0.5 GHz - 1.0 GHz	15.5	18.6	22.0	-	-15.3	-6.5	-	-6.7	-4.5	$V_{_{\rm DD}}$ = 50 V, $I_{_{\rm DQ}}$ = 500 mA
1.0 GHz - 2.0 GHz	15.5	18.6	22.0	-	-15.3	-12.5	-	-6.7	-4.5	$V_{_{\rm DD}}$ = 50 V, $I_{_{\rm DQ}}$ = 500 mA
2.0 GHz - 3.0 GHz	13.0	18.6	20.0	-	-15.3	-12.5	-	-6.0	-2.5	$V_{_{\rm DD}}$ = 50 V, $I_{_{\rm DQ}}$ = 500 mA

-14.2

-6.5

-5.3

-2.5

Notes:

3.0 GHz - 6.0 GHz

 1 P_{_{OUT}} is defined as P_{_{IN}} = 32 dBm.

² The device will draw approximately 55-70 mA at pinch off due to the internal circuit structure.

20.0

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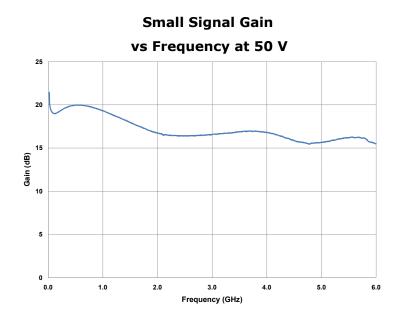
 $V_{_{\rm DD}}$ = 50 V, $I_{_{\rm DQ}}$ = 500 mA

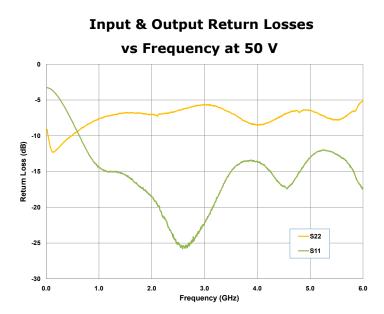
13.0

16.3

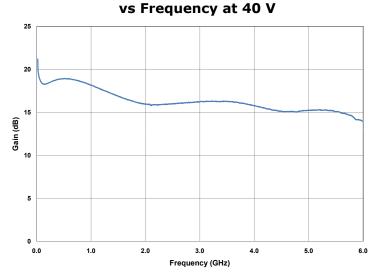


Typical Performance

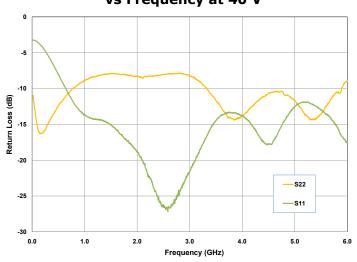




Small Signal Gain



Input & Output Return Losses vs Frequency at 40 V

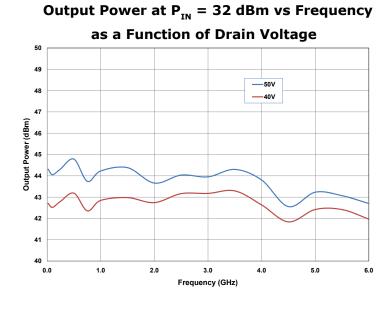


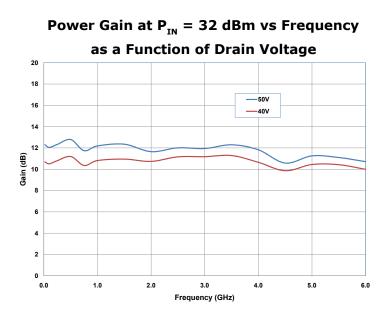
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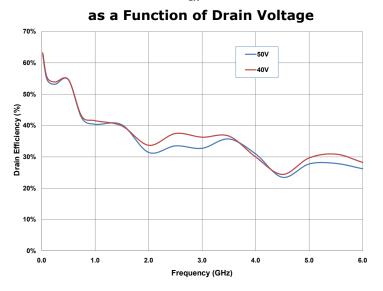


Typical Performance





Drain Efficiency at P_{IN} = 32 dBm vs Frequency

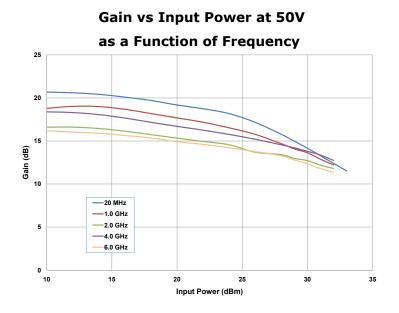


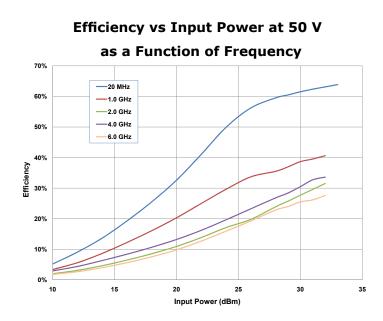
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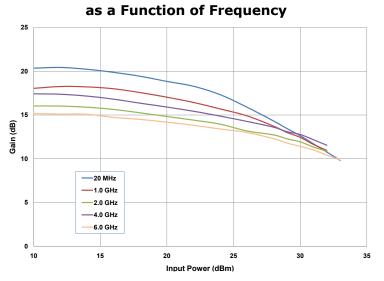


Typical Performance



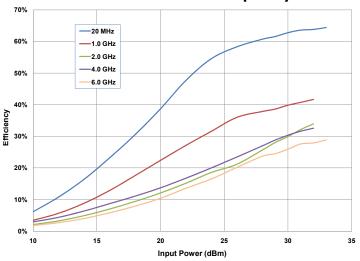


Gain vs Input Power at 40V



Efficiency vs Input Power at 40 V

as a Function of Frequency



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General Device Information

The CMPA0060025F is a GaN HEMT MMIC Power Amplifier, which operates between 20 MHz - 6.0 GHz. The amplifier typically provides 17 dB of small signal gain and 25 W saturated output power with an associated power added efficiency of better than 20 %. The wideband amplifier's input and output are internally matched to 50 Ohm. The amplifier requires bias from appropriate Bias-T's, through the RF input and output ports.

The CMPA0060025F is provided in a flange package format. The input and output connections are gold plated to enable gold bond wire attach at the next level assembly.

The measurements in this data sheet were taken on devices wire-bonded to the test fixture with 2 mil gold bond wires. The CMPA0060025F-TB and the device were then measured using external Bias-T's, (TECDIA: TBT-H06M20 or similar), as shown in Figure 2. The Bias-T's were included in the calibration of the test system. All other losses associated with the test fixture are included in the measurements.

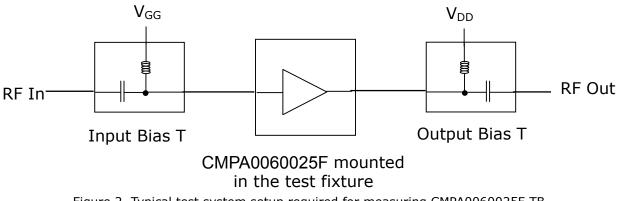


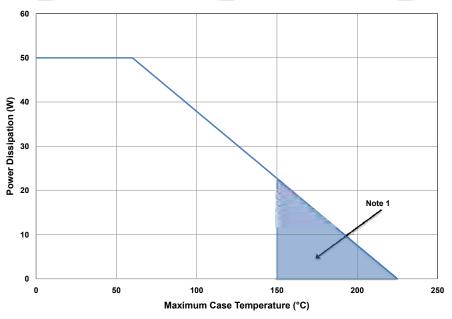
Figure 2. Typical test system setup required for measuring CMPA0060025F-TB

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CMPA0060025F Power Dissipation De-rating Curve



Note 1. Area exceeds Maximum Case Operating Temperature (See Page 2).

Electrostatic Discharge (ESD) Classifications

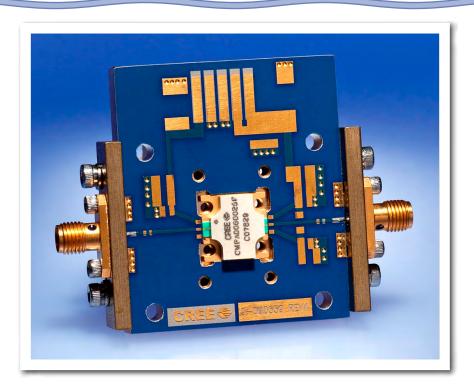
Parameter	Symbol	Class	Test Methodology
Human Body Model	НВМ	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	II (200 < 500 V)	JEDEC JESD22 C101-C

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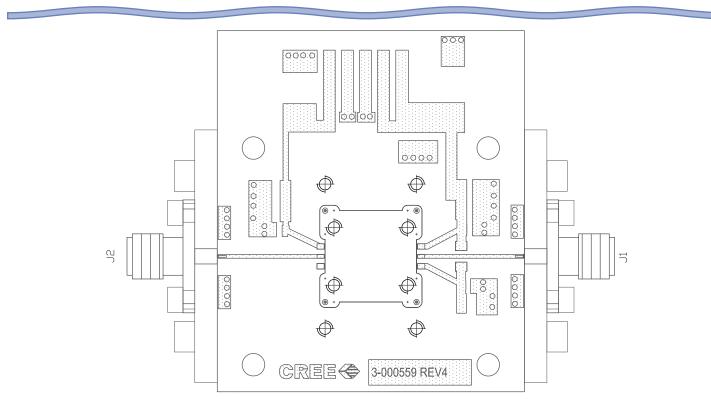
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CMPA0060025F-TB Demonstration Amplifier Circuit



CMPA0060025F-TB Demonstration Amplifier Circuit Outline



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CMPA0060025F-TB Demonstration Amplifier Circuit Bill of Materials

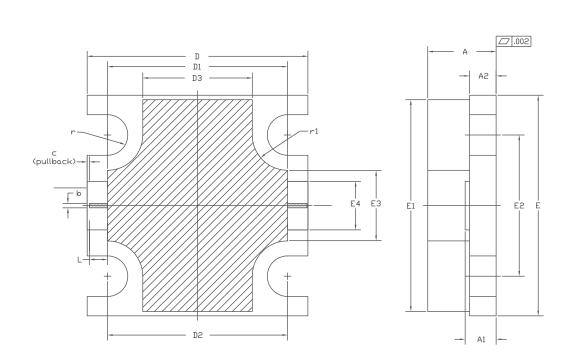
Designator	Description	Qty
J1,J2	CONNECTOR, SMA, AMP1052901-1	2
-	PCB, TACONIC, RF-35-0100-CH/CH	1
Q1	CMPA0060025F	1

Notes

¹ The CMPA0060025F is connected to the PCB with 2.0 mil Au bond wires.

² An external bias T is required.

Product Dimensions CMPA0060025F (Package Type - 780019)



NDTES

1. DIMENSIONING AND TOLERANICING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION INCH. 3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020' BEYOND EDGE OF LID.

 LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
 ALL PLATED SURFACES ARE NI/AU

INCLIES MIL

	INCHES		MILLIN	NOTE		
DIM	MIN	MAX	MIN	MAX	NOTE	
A	0.148	0.162	3.76	4.12	-	
A1	0.066	0.076	1.67	1.93	-	
A2	0.056	0.064	1.42	1.63	-	
b	0.0	09	0.	24	×2	
с	0.0	05	0.	0.13		
D	0.495	0.505	12.57	12.83	-	
D1	0.403	0.413	10.23	10.49	-	
D2	0.408		10.36		-	
D3	0.243	0.253	6.17	6.43	-	
E	0.495	0.505	12.57	12.83	-	
E1	0.475	0.485	12.06	12.32	-	
E2	0.320		8.13		-	
E3	0.155	0.165	3.93	4.19	-	
E4	0.105	0.115	2.66	2.92	_	
L	0.041		1.04		×2	
r	R0.046		R1.17		×4	
r1	R0.080		R2	R2.03		

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